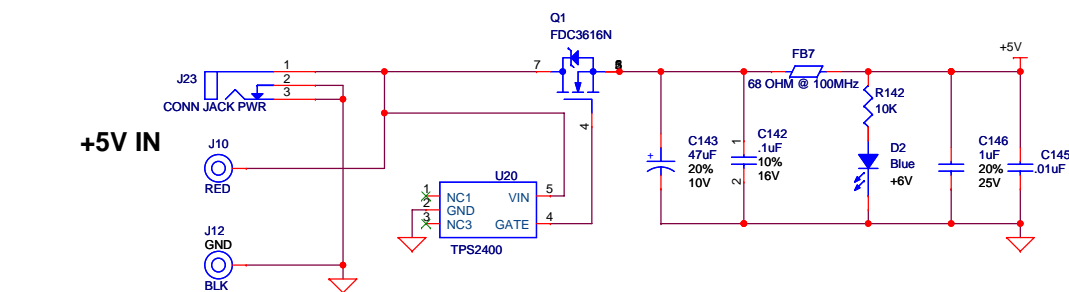
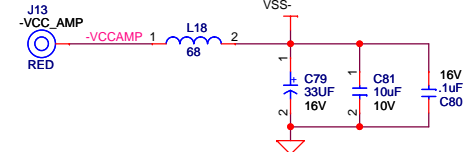
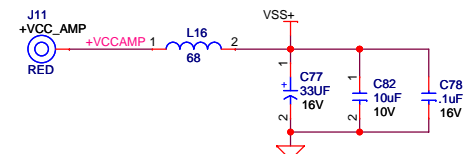
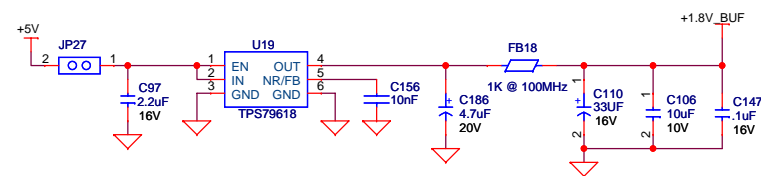
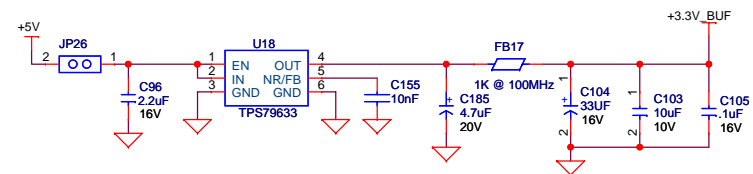
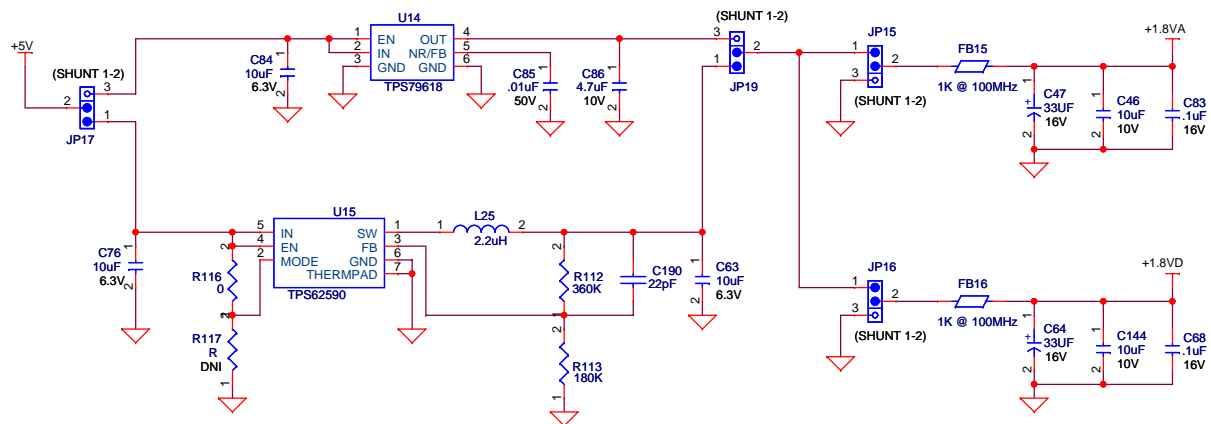
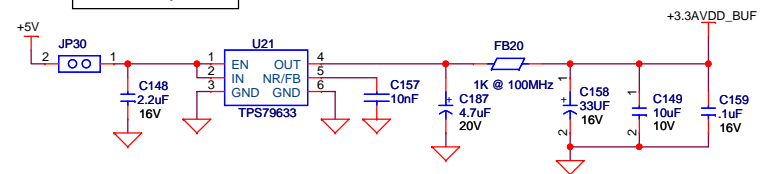


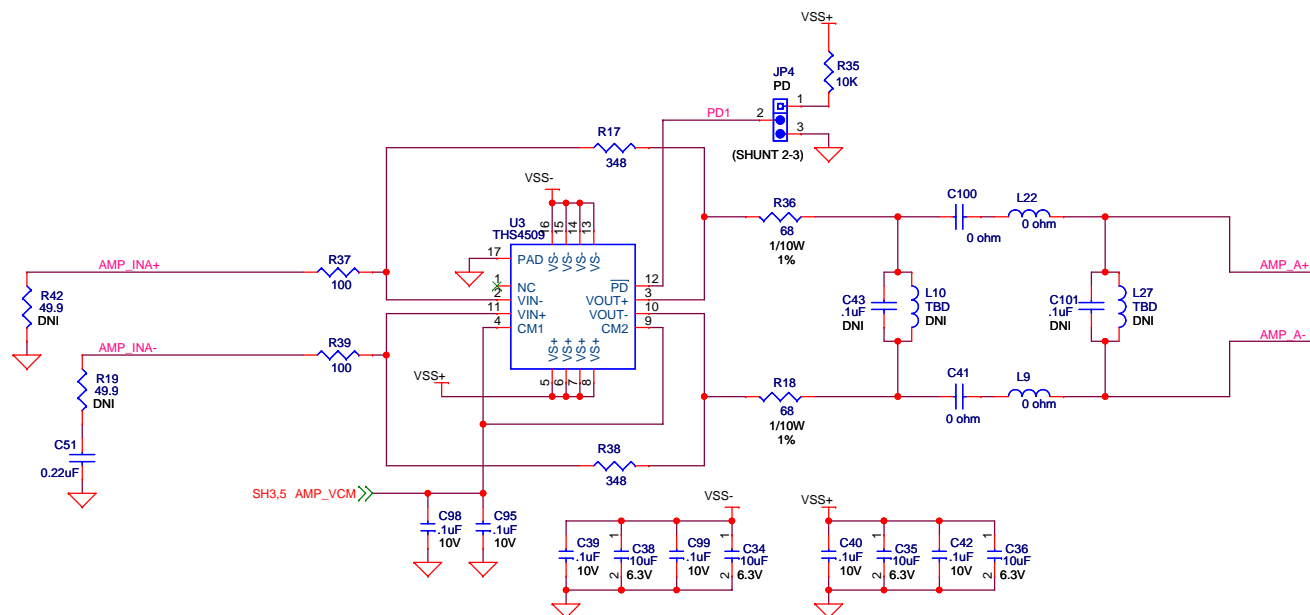
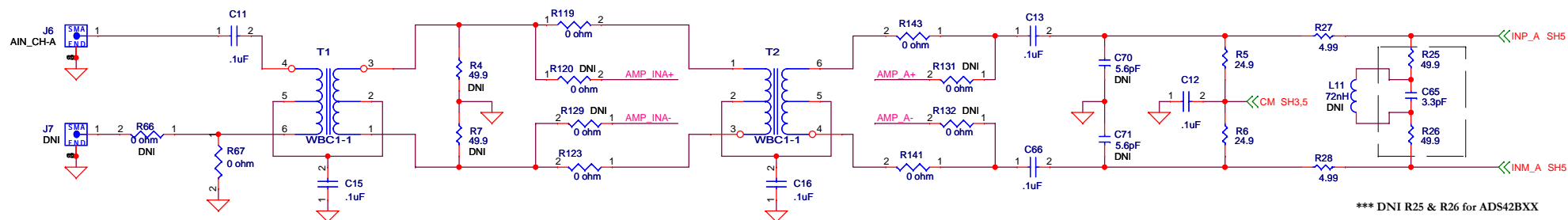
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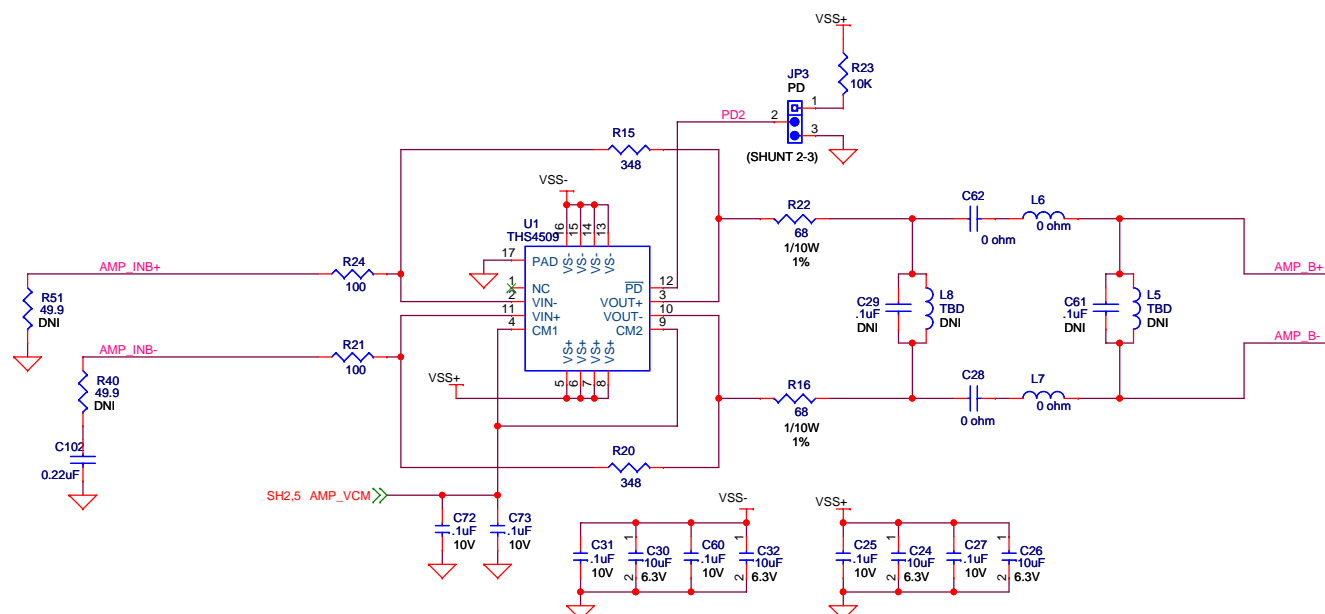
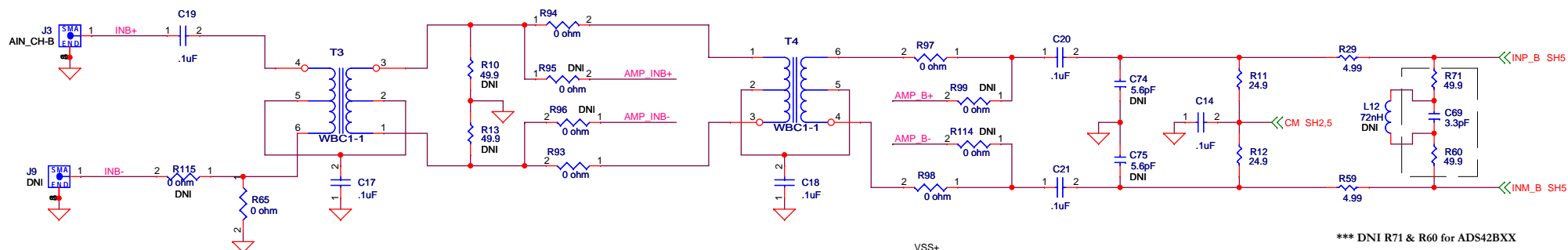
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ADS42XX/58C28 EVM		
Size	Document Number	Rev
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Drawn: L. Nguyen	Date: Friday, January 28, 2011	Sheet 1 of 7
Engineer: HQ. Liu		

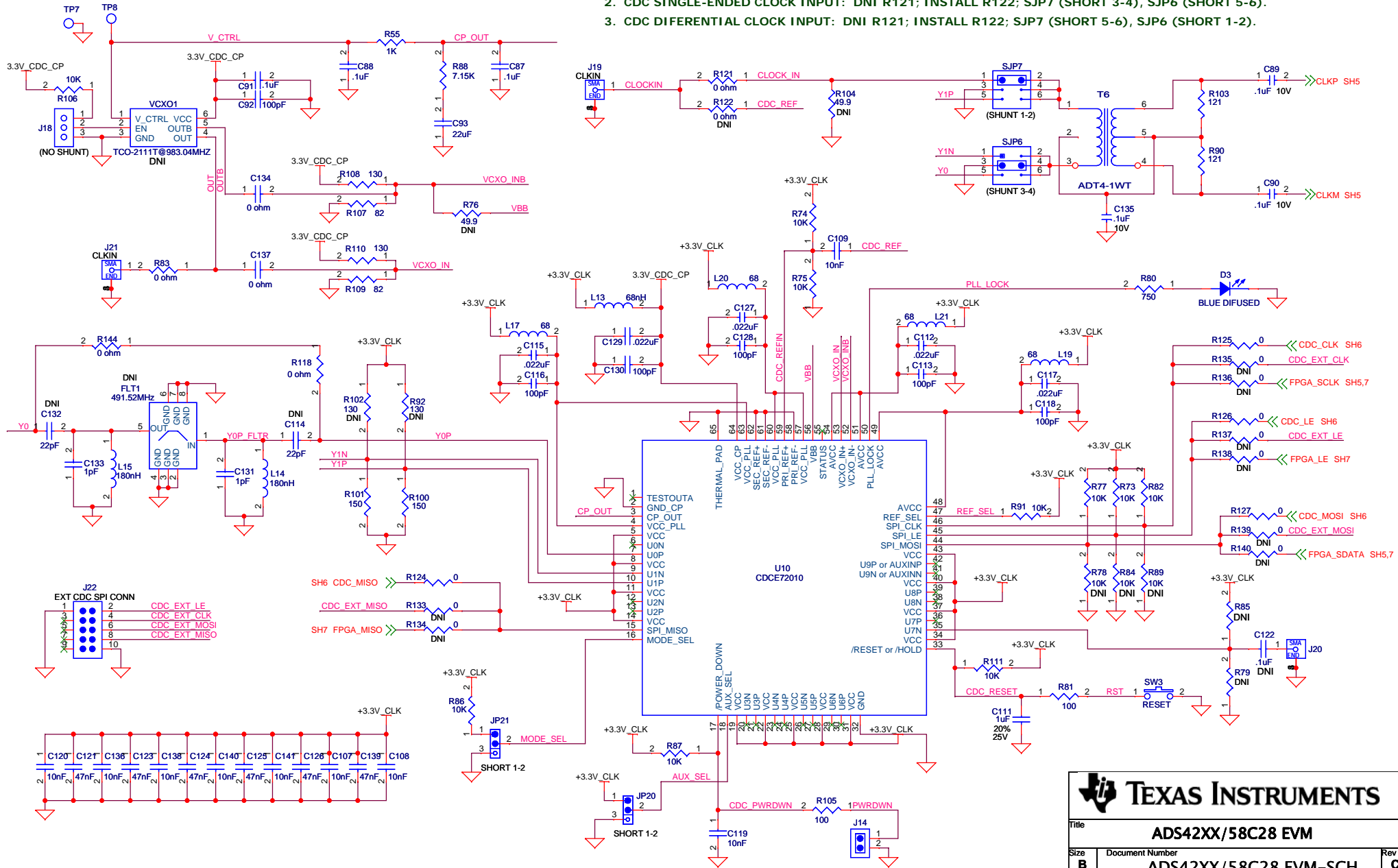


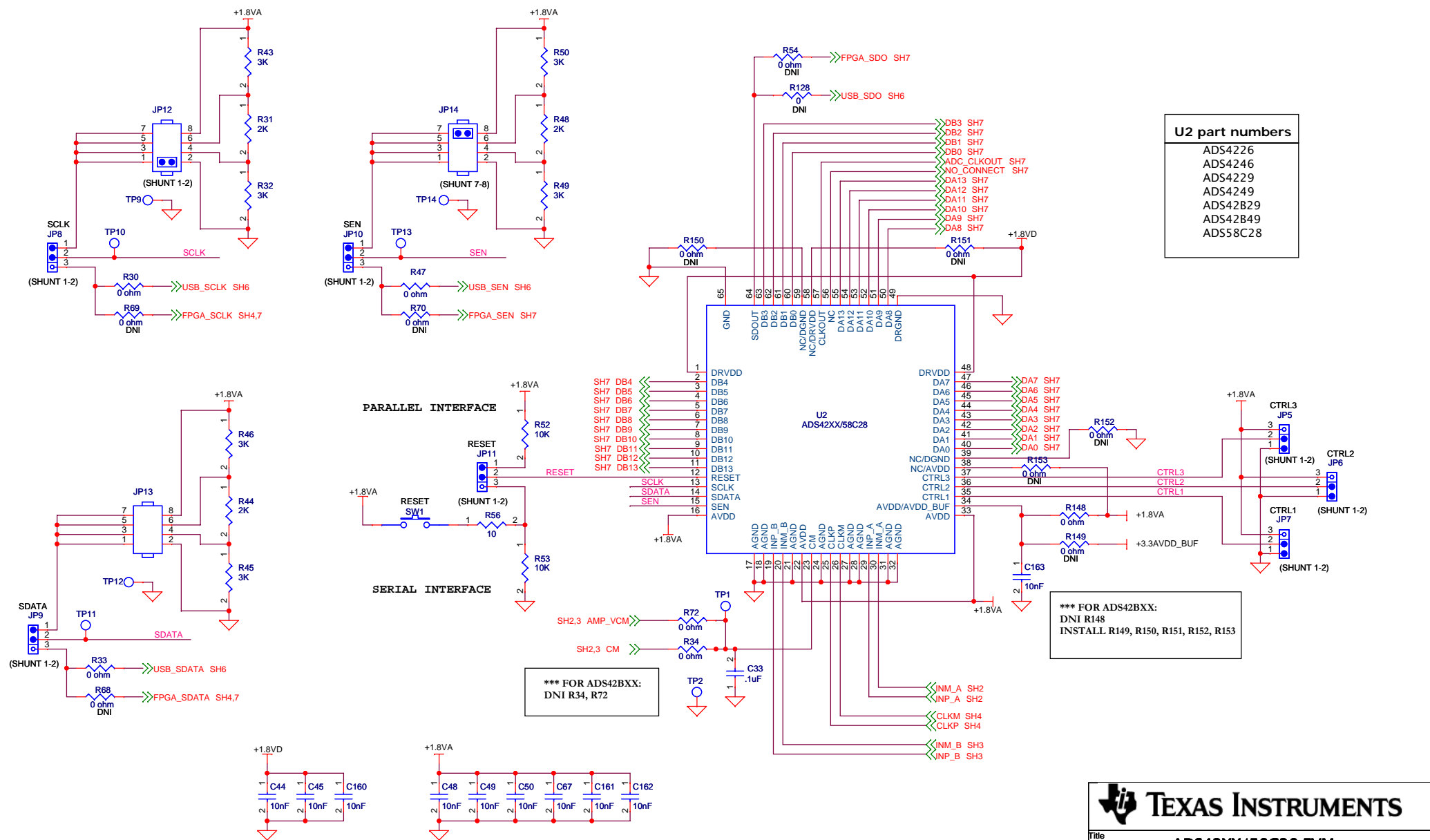
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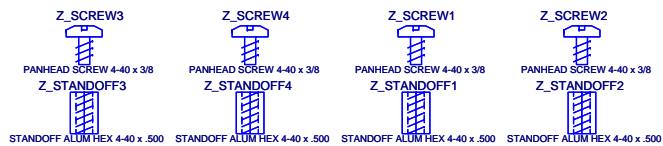
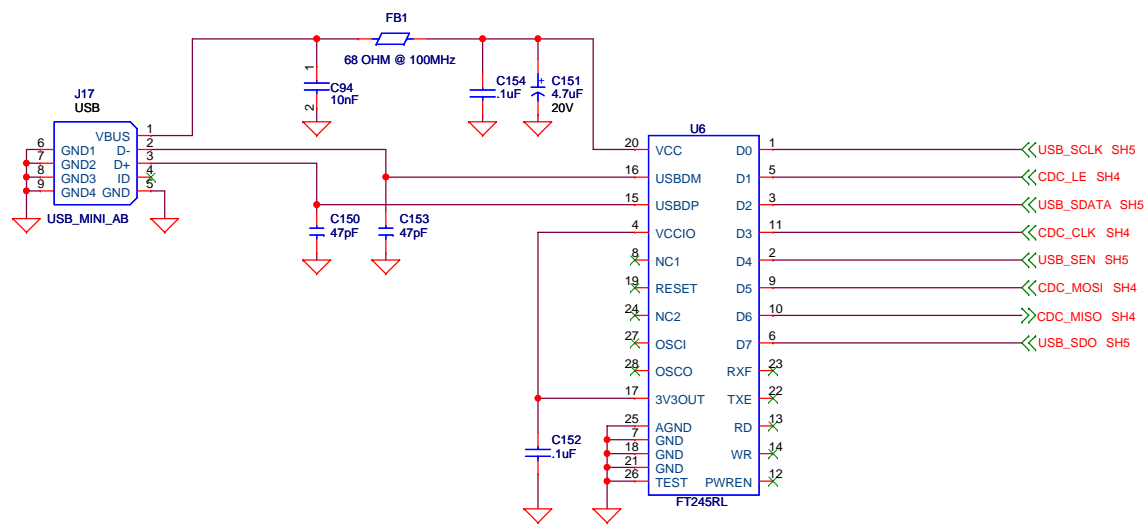


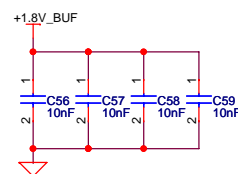
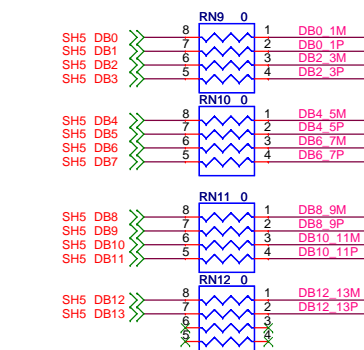
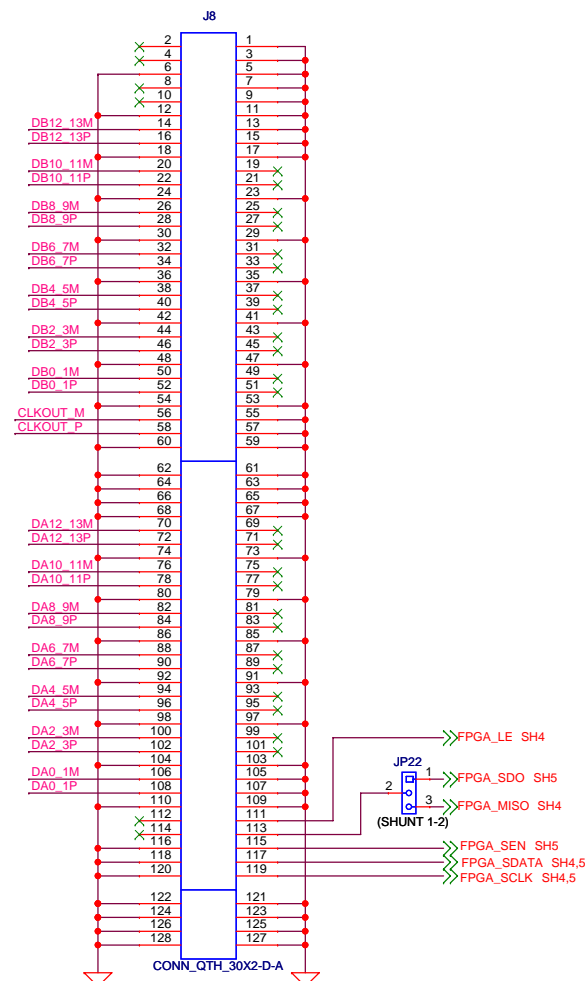
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2. CDC SINGLE-ENDED CLOCK INPUT: DNI R121; INSTALL R122; SJP7 (SHORT 3-4), SJP6 (SHORT 5-6).
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